



IFW

**PATENT APPLICATION**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of

Docket No: Q95523 ,

Shigeru TANAKA, et al.

Appln. No.: 10/588,264

Group Art Unit: to be assigned

Confirmation No.: to be assigned

Examiner: to be assigned

Filed: August 3, 2006

For: THERMOSETTING RESIN COMPOSITION AND USE THEREOF

**LETTER**

**MAIL STOP AMENDMENT**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

Further to the Information Disclosure Statement filed August 3, 2006, for the convenience of the Examiner, Applicant is now able to provide, and attaches hereto, a copy of an English translation of the International Preliminary Report on Patentability (IPRP).

No additional cited art documents are submitted or listed herewith, since the documents cited in the IPRP were previously cited and listed in the Information Disclosure Statement filed August 3, 2006.

Respectfully submitted,

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Date: October 23, 2006